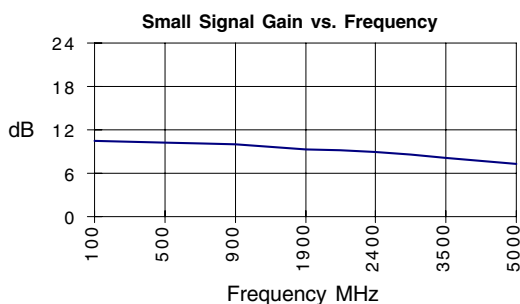


Product Description

Stanford Microdevices' SGA-2186 is a high performance cascadeable 50-ohm amplifier designed for operation from a 2.2-volt supply. This RFIC uses the latest Silicon Germanium Heterostructure Bipolar Transistor (SiGe HBT) process featuring 1 micron emitters with f_T up to 65 GHz.

This circuit uses a darlington pair topology with resistive feedback for broadband performance as well as stability over its entire temperature range. Internally matched to 50 ohm impedance, the SGA-2186 requires only DC blocking and bypass capacitors for external components.



Preliminary

SGA-2186

DC-5000 MHz Silicon Germanium HBT Cascadeable Gain Block



Product Features

- DC-5000 MHz Operation
- 2.2V Single Voltage Supply
- High Output Intercept: +20dBm typ. at 850 MHz
- Low Power Consumption: 20mA
- Low Bias Operation: Can operate with 2V supply

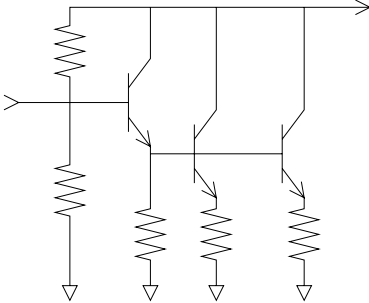
Applications

- Broadband Gain Blocks
- Cordless Phones
- IF/ RF Buffer Amplifier
- Drivers for CATV Amplifiers

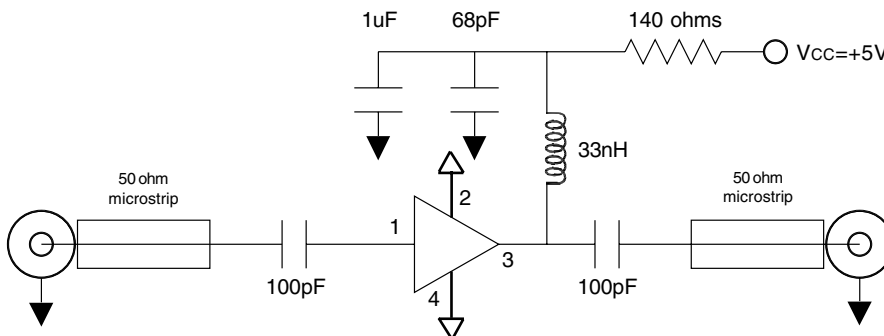
Symbol	Parameters: Test Conditions: $Z_0 = 50 \text{ Ohms}$, $I_d = 20 \text{ mA}$, $T = 25^\circ\text{C}$		Units	Min.	Typ.	Max.
P_{1dB}	Output Power at 1dB Compression	$f = 850 \text{ MHz}$ $f = 1950 \text{ MHz}$	dBm dBm		7.5 6.7	
S_{21}	Small Signal Gain	$f = \text{DC} - 1000 \text{ MHz}$ $f = 1000 - 2000 \text{ MHz}$ $f = 2000 - 5000 \text{ MHz}$	dB dB dB	9.3	10.3 9.3 8.5	
S_{12}	Reverse Isolation	$f = \text{DC} - 1000 \text{ MHz}$ $f = 1000 - 2000 \text{ MHz}$ $f = 2000 - 5000 \text{ MHz}$	dB dB dB		15.3 16.0 16.5	
S_{11}	Input VSWR	$f = \text{DC} - 2400 \text{ MHz}$ $f = 2400 - 5000 \text{ MHz}$	-		1.35:1 1.53:1	
S_{22}	Output VSWR	$f = \text{DC} - 2400 \text{ MHz}$ $f = 2400 - 5000 \text{ MHz}$	-		1.20:1 1.30:1	
IP_3	Third Order Intercept Point	$f = 850 \text{ MHz}$ $f = 1950 \text{ MHz}$	dBm dBm		20.0 19.6	
NF	Noise Figure	$f = \text{DC} - 1000 \text{ MHz}$ $f = 1000 - 2400 \text{ MHz}$	dB dB		4.3 4.7	
T_D	Group Delay	$f = 1000 \text{ MHz}$	pS		119.0	
V_D	Device Voltage		V	1.9	2.2	2.5

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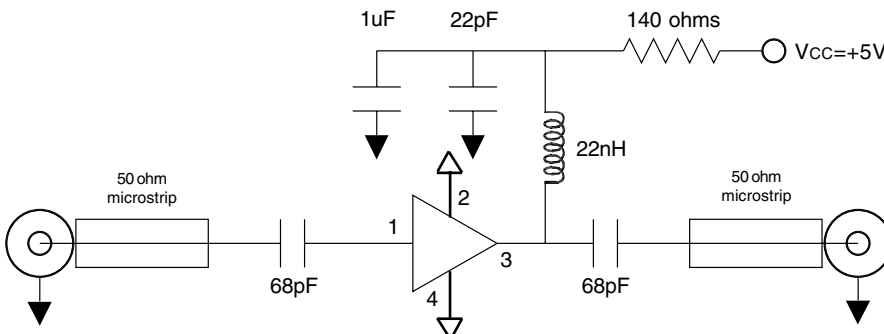
Parameter	Specification			Unit	Test Condition
	Min	Typ.	Max.		
Device Bias					T= 25C
Operating Voltage		2.2		V	
Operating Current		20.0		mA	
500 MHz					T= 25C
Gain		10.3		dB	
Noise Figure		4.2		dB	
Output IP3		20.7		dBm	
Output P1dB		7.4		dBm	
Input Return Loss		20.6		dB	
Isolation		15.2		dB	
850 MHz					T= 25C
Gain		10.1		dB	
Noise Figure		4.3		dB	
Output IP3		20.0		dBm	
Output P1dB		7.5		dBm	
Input Return Loss		19.1		dB	
Isolation		15.4		dB	
1950 MHz					T= 25C
Gain		9.3		dB	
Noise Figure		4.7		dB	
Output IP3		19.6		dBm	
Output P1dB		6.7		dBm	
Input Return Loss		17.8		dB	
Isolation		16.2		dB	
2400 MHz					T= 25C
Gain		8.9		dB	
Noise Figure		4.8		dB	
Output IP3		19.4		dBm	
Output P1dB		6.3		dBm	
Input Return Loss		16.6		dB	
Isolation		16.6		dB	

Pin #	Function	Description	Device Schematic
1	RF IN	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.	
2	GND	Connection to ground. Use via holes for best performance to reduce lead inductance as close to ground leads as possible.	
3	RF OUT/BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC blocking capacitor is necessary for proper operation.	
4	GND	Sames as Pin 2	

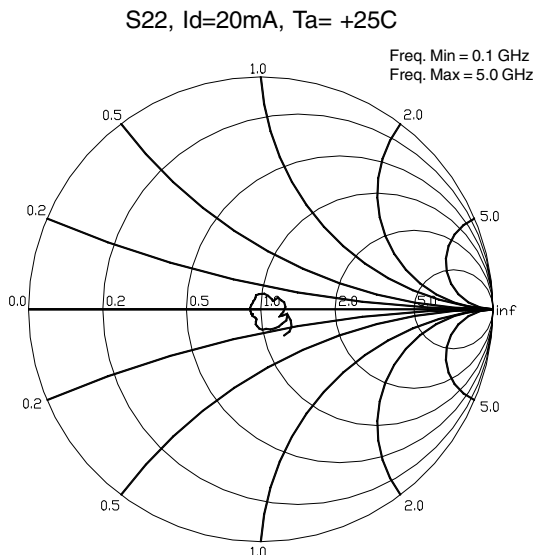
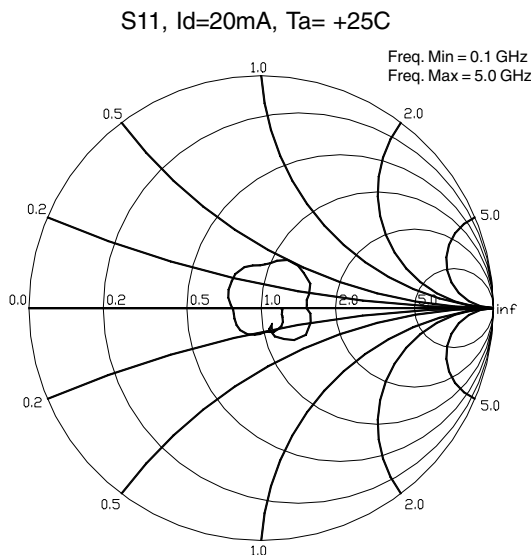
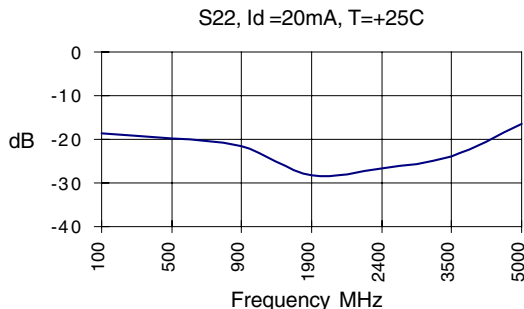
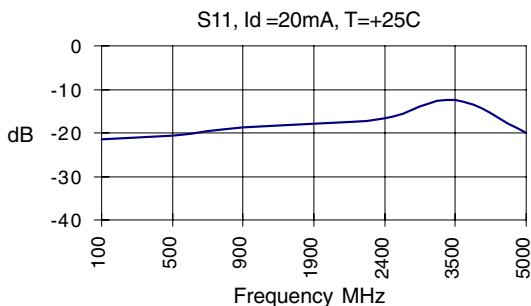
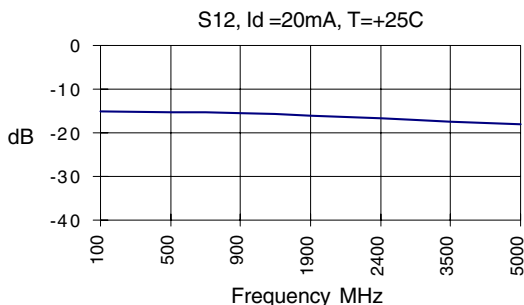
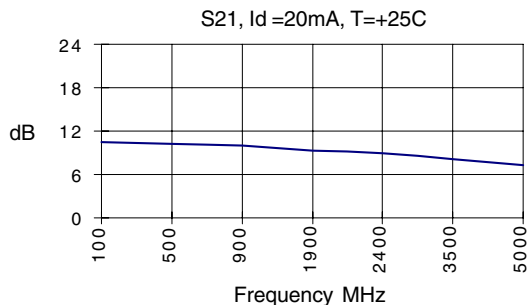
Application Schematic for +5V Operation at 900 MHz



Application Schematic for +5V Operation at 1900 MHz

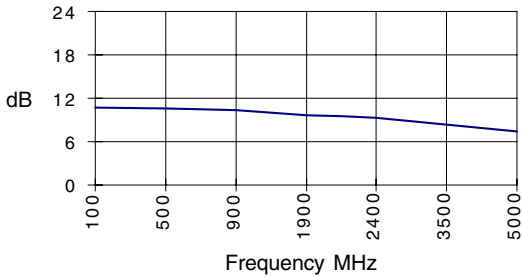


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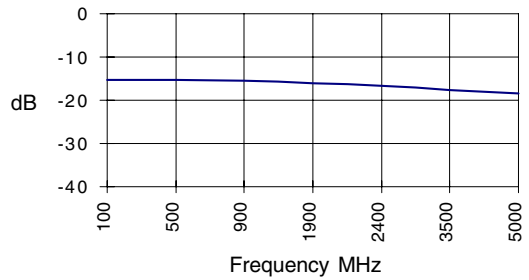


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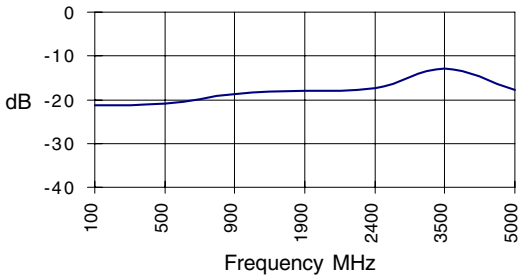
S21, Id =20mA, T=-40C



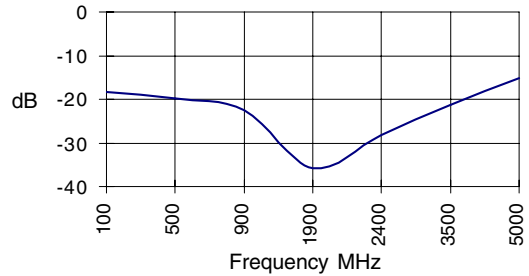
S12, Id =20mA, T=-40C



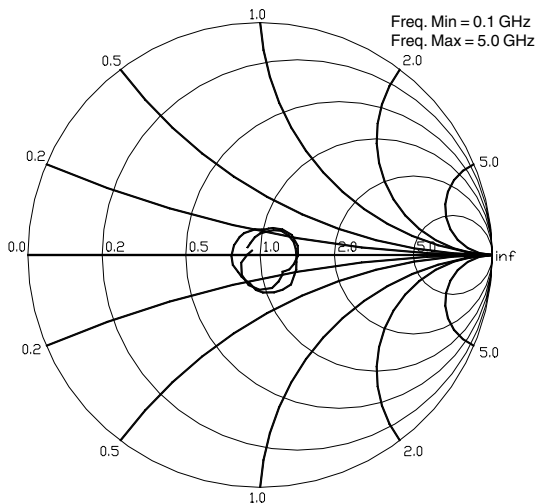
S11, Id =20mA, T=-40C



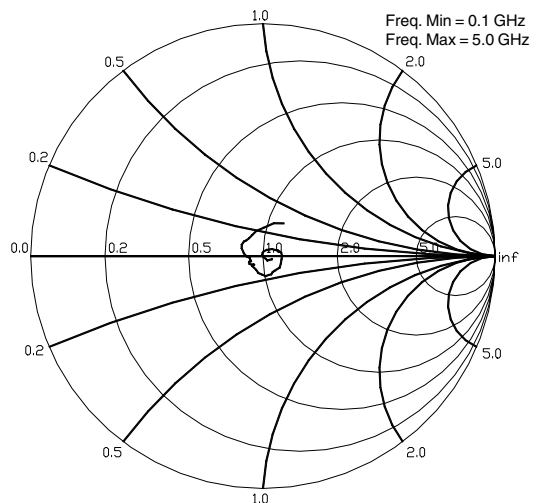
S22, Id =20mA, T=-40C



S11, Id=20mA, Ta= -40C

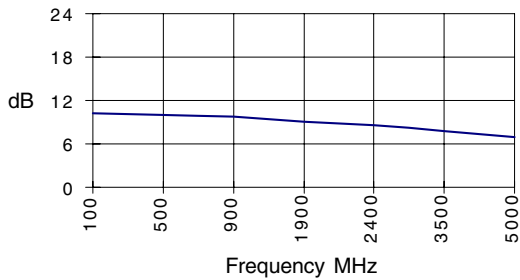


S22, Id=20mA, Ta= -40C

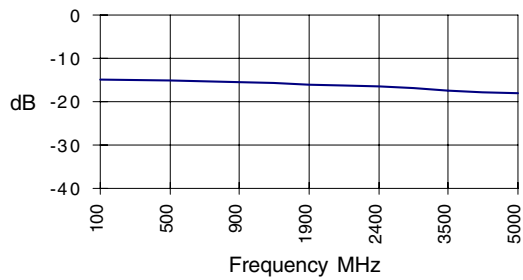


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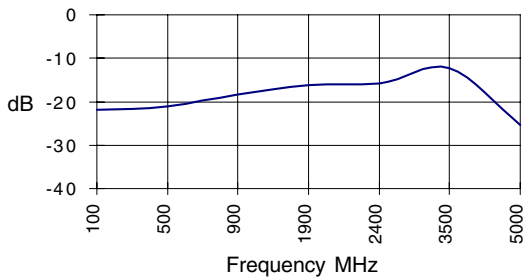
S21, Id =20mA, T=85C



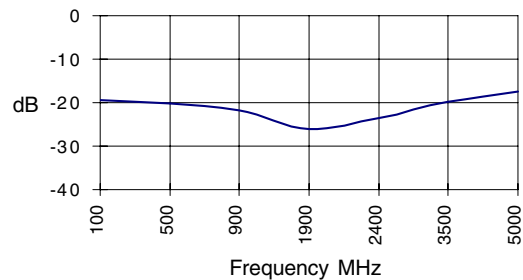
S12, Id =20mA, T=85C



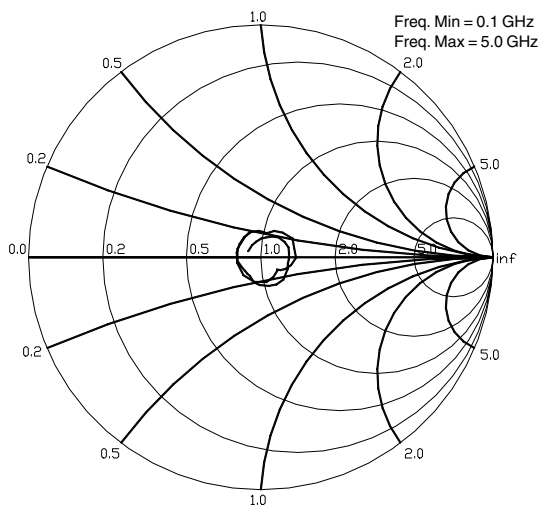
S11, Id =20mA, T=85C



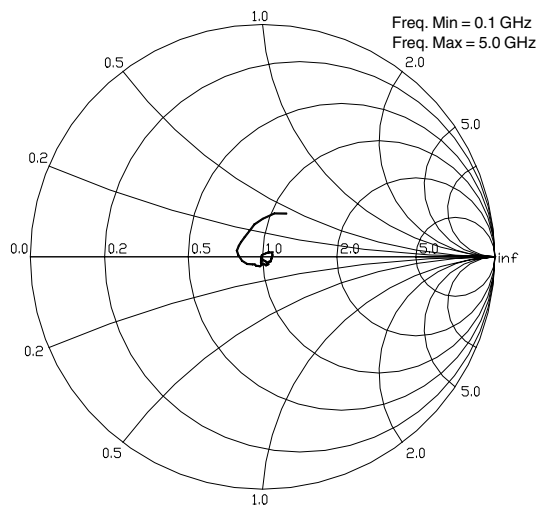
S22, Id =20mA, T=85C



S11, Id=20mA, Ta= 85C



S22, Id=20mA, Ta= 85C



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Absolute Maximum Ratings

Parameter	Value	Unit
Supply Current	40	mA
Operating Temperature	-40 to +85	C
Maximum Input Power	+13	dBm
Storage Temperature Range	-40 to +85	C
Operating Junction Temperature	+150	C

Caution:



Operation of this device above any one of these parameters may cause permanent damage. Appropriate precautions in handling, packaging and testing devices must be observed.

Thermal Resistance (Lead-Junction):

97° C/W

Part Number Ordering Information

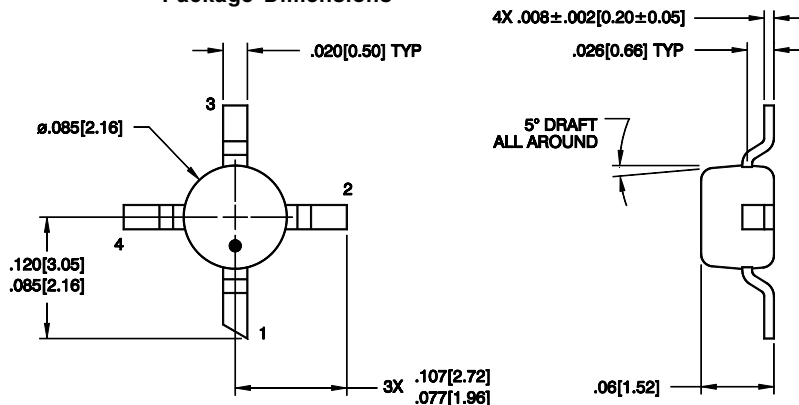
Part Number	Reel Size	Devices/Reel
SGA-2186-TR1	7"	1000
SGA-2186-TR2	13"	3000

Recommended Bias Resistor Values

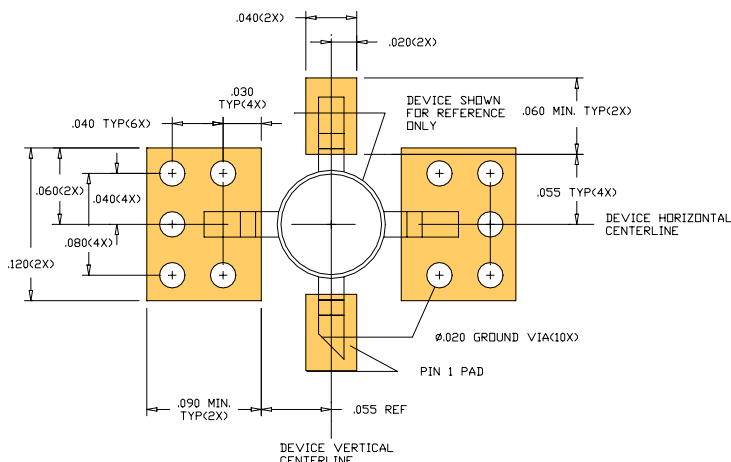
Supply Voltage(Vs)	3V	5V	7.5V	9V	12V
Rbias (Ohms)	40	140	265	340	490

Package Dimensions

Pin Designation	
1	RF in
2	GND
3	RF out and Bias
4	GND



PCB Pad Layout



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